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Should be replaced with:

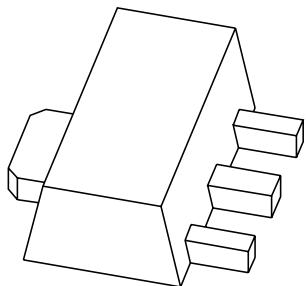
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Kind regards,

Team Nexperia

DATA SHEET



PXT4401 NPN switching transistor

Product data sheet
Supersedes data of 1999 Apr 14

2004 Nov 22

NPN switching transistor**PXT4401****FEATURES**

- High current (max. 600 mA)
- Low voltage (max. 40 V).

APPLICATIONS

- Switching and linear amplification in industrial and consumer applications.

DESCRIPTION

NPN switching transistor in a SOT89 plastic package.
PNP complement: PXT4403.

MARKING

| TYPE NUMBER | MARKING CODE ⁽¹⁾ |
|-------------|-----------------------------|
| PXT4401 | *2X |

Note

1. * = p: Made in Hong Kong.
- * = t: Made in Malaysia.
- * = W: Made in China.

ORDERING INFORMATION

| TYPE NUMBER | PACKAGE | | |
|-------------|---------|--|---------|
| | NAME | DESCRIPTION | VERSION |
| PXT4401 | SC-62 | plastic surface mounted package; collector pad for good heat transfer; 3 leads | SOT89 |

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | emitter |
| 2 | collector |
| 3 | base |

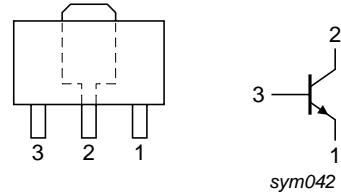


Fig.1 Simplified outline (SOT89) and symbol.

NPN switching transistor

PXT4401

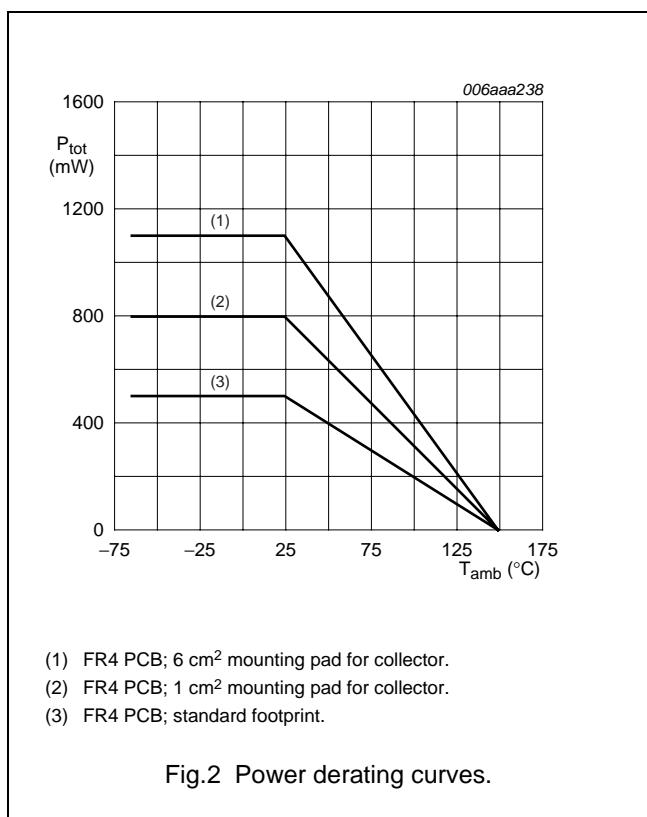
LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-----------|---------------------------|---|------|-------------------|------|
| V_{CBO} | collector-base voltage | open emitter | – | 60 | V |
| V_{CEO} | collector-emitter voltage | open base | – | 40 | V |
| V_{EBO} | emitter-base voltage | open collector | – | 5 | V |
| I_C | collector current (DC) | | – | 600 | mA |
| I_{CM} | peak collector current | | – | 800 | mA |
| I_{BM} | peak base current | | – | 200 | mA |
| P_{tot} | total power dissipation | $T_{amb} \leq 25^\circ\text{C}$ note 1 note 2 note 3 | | 0.5 0.8 1.1 | W |
| T_{stg} | storage temperature | | –65 | +150 | °C |
| T_j | junction temperature | | – | 150 | °C |
| T_{amb} | ambient temperature | | –65 | +150 | °C |

Notes

1. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm².
3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm².



NPN switching transistor

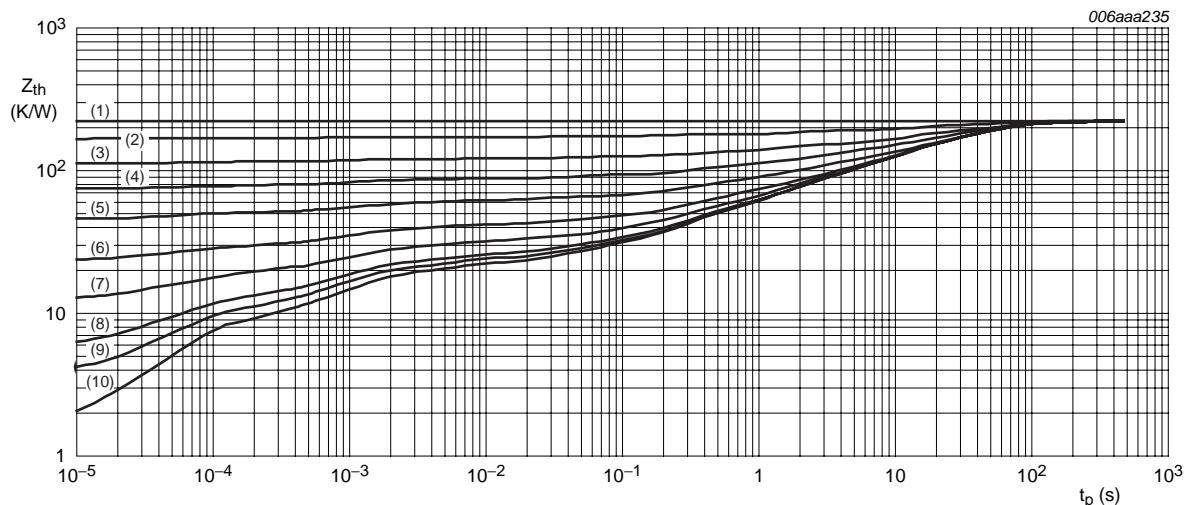
PXT4401

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|---|---|-------------------|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air note 1 note 2 note 3 | 250 156 113 | K/W |
| $R_{th(j-s)}$ | thermal resistance from junction to soldering point | | 30 | K/W |

Notes

1. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm².
3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm².



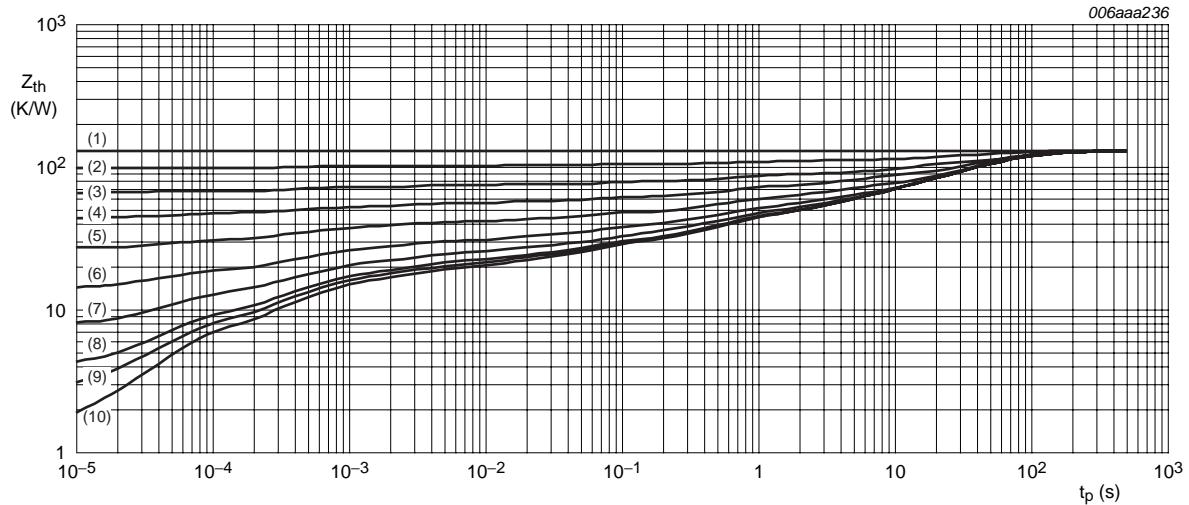
Mounted on FR4 printed-circuit board; standard footprint.

(1) $\delta = 1.$ (3) $\delta = 0.5.$ (5) $\delta = 0.2.$ (7) $\delta = 0.05.$ (9) $\delta = 0.01.$
 (2) $\delta = 0.75.$ (4) $\delta = 0.33.$ (6) $\delta = 0.1.$ (8) $\delta = 0.02.$ (10) $\delta = 0.$

Fig.3 Transient thermal impedance as a function of pulse time; typical values.

NPN switching transistor

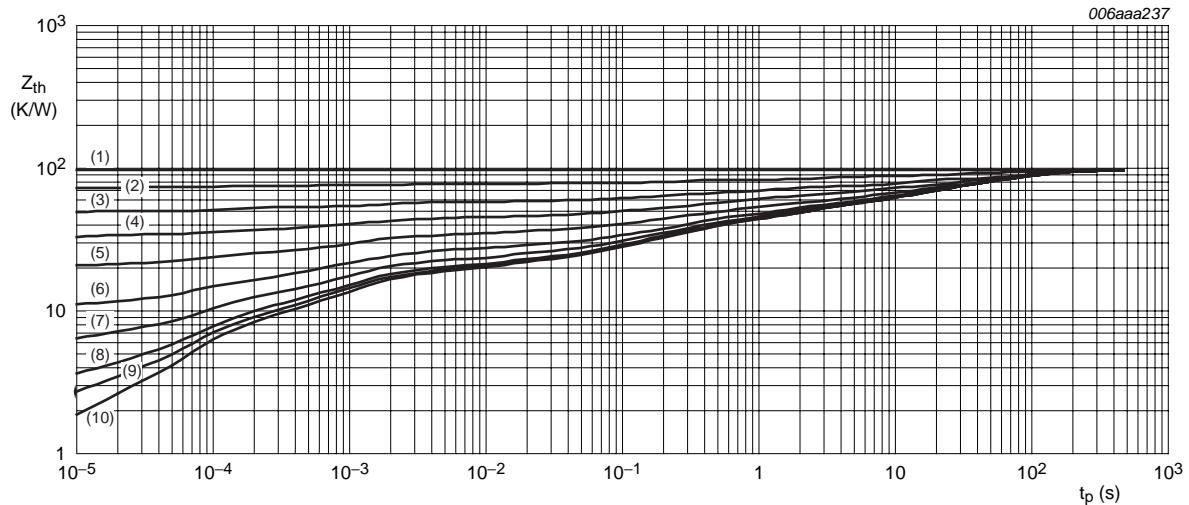
PXT4401



Mounted on FR4 printed-circuit board; mounting pad for collector 1 cm^2 .

| | | | | |
|----------------------|----------------------|---------------------|----------------------|----------------------|
| (1) $\delta = 1.$ | (3) $\delta = 0.5.$ | (5) $\delta = 0.2.$ | (7) $\delta = 0.05.$ | (9) $\delta = 0.01.$ |
| (2) $\delta = 0.75.$ | (4) $\delta = 0.33.$ | (6) $\delta = 0.1.$ | (8) $\delta = 0.02.$ | (10) $\delta = 0.$ |

Fig.4 Transient thermal impedance as a function of pulse time; typical values.



Mounted on FR4 printed-circuit board; mounting pad for collector 6 cm^2 .

| | | | | |
|----------------------|----------------------|---------------------|----------------------|----------------------|
| (1) $\delta = 1.$ | (3) $\delta = 0.5.$ | (5) $\delta = 0.2.$ | (7) $\delta = 0.05.$ | (9) $\delta = 0.01.$ |
| (2) $\delta = 0.75.$ | (4) $\delta = 0.33.$ | (6) $\delta = 0.1.$ | (8) $\delta = 0.02.$ | (10) $\delta = 0.$ |

Fig.5 Transient thermal impedance as a function of pulse time; typical values.

NPN switching transistor

PXT4401

CHARACTERISTICS

 $T_{amb} = 25^\circ C$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-------------|--------------------------------------|---|------|------|------|
| I_{CBO} | collector-base cut-off current | $I_E = 0 A$; $V_{CB} = 60 V$ | — | 50 | nA |
| I_{EBO} | emitter-base cut-off current | $I_C = 0 A$; $V_{EB} = 6 V$ | — | 50 | nA |
| h_{FE} | DC current gain | $V_{CE} = 1 V$; (see Fig.6) | 20 | — | |
| | | $I_C = 0.1 mA$ | 20 | — | |
| | | $I_C = 1 mA$ | 40 | — | |
| | | $I_C = 10 mA$ | 80 | — | |
| | | $I_C = 150 mA$; note 1 | 100 | 300 | |
| | | $I_C = 500 mA$; $V_{CE} = 2 V$; note 1 | 40 | — | |
| V_{CEsat} | collector-emitter saturation voltage | $I_C = 150 mA$; $I_B = 15 mA$; note 1 | — | 400 | mV |
| | | $I_C = 500 mA$; $I_B = 50 mA$; note 1 | — | 750 | mV |
| V_{BEsat} | base-emitter saturation voltage | $I_C = 150 mA$; $I_B = 15 mA$; note 1 | — | 950 | mV |
| | | $I_C = 500 mA$; $I_B = 50 mA$; note 1 | — | 1.2 | V |
| C_c | collector capacitance | $I_E = i_e = 0 A$; $V_{CB} = 5 V$; $f = 1 MHz$ | — | 8 | pF |
| C_e | emitter capacitance | $I_C = i_c = 0 A$; $V_{EB} = 500 mV$; $f = 1 MHz$ | — | 30 | pF |
| f_T | transition frequency | $I_C = 20 mA$; $V_{CE} = 10 V$; $f = 100 MHz$ | 250 | — | MHz |

Switching times (between 10% and 90% levels); (see Fig.7)

| | | | | | |
|-----------|---------------|---|---|-----|----|
| t_{on} | turn-on time | $I_{Con} = 150 mA$; $I_{Bon} = 15 mA$; $I_{Boff} = -15 mA$ | — | 35 | ns |
| t_d | delay time | | — | 15 | ns |
| t_r | rise time | | — | 20 | ns |
| t_{off} | turn-off time | | — | 250 | ns |
| t_s | storage time | | — | 200 | ns |
| t_f | fall time | | — | 60 | ns |

Note

1. Pulse test: $t_p \leq 300 \mu s$; $\delta \leq 0.02$.

NPN switching transistor

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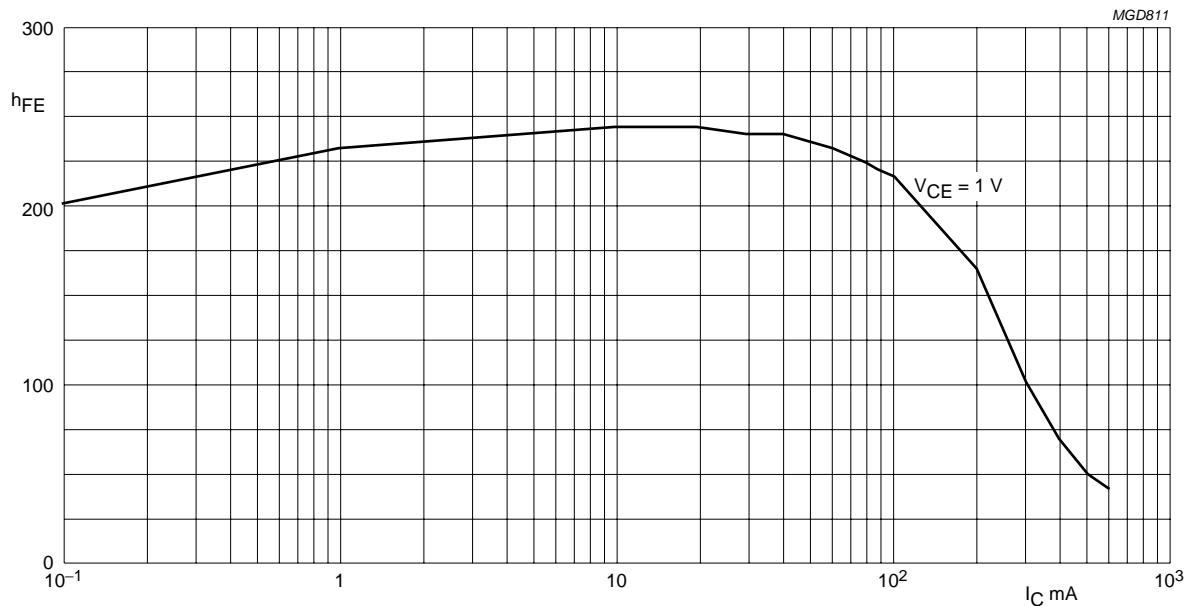
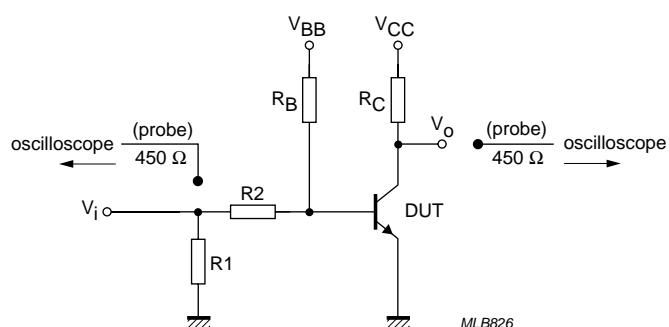


Fig.6 DC current gain; typical values.



$V_i = 9.5$ V; $T = 500$ μ s; $t_p = 10$ μ s; $t_r = t_f \leq 3$ ns.

$R1 = 68 \Omega$; $R2 = 325 \Omega$; $R_B = 325 \Omega$; $R_C = 160 \Omega$.

$V_{BB} = -3.5$ V; $V_{CC} = 29.5$ V.

Oscilloscope: input impedance $Z_i = 50 \Omega$.

Fig.7 Test circuit for switching times.

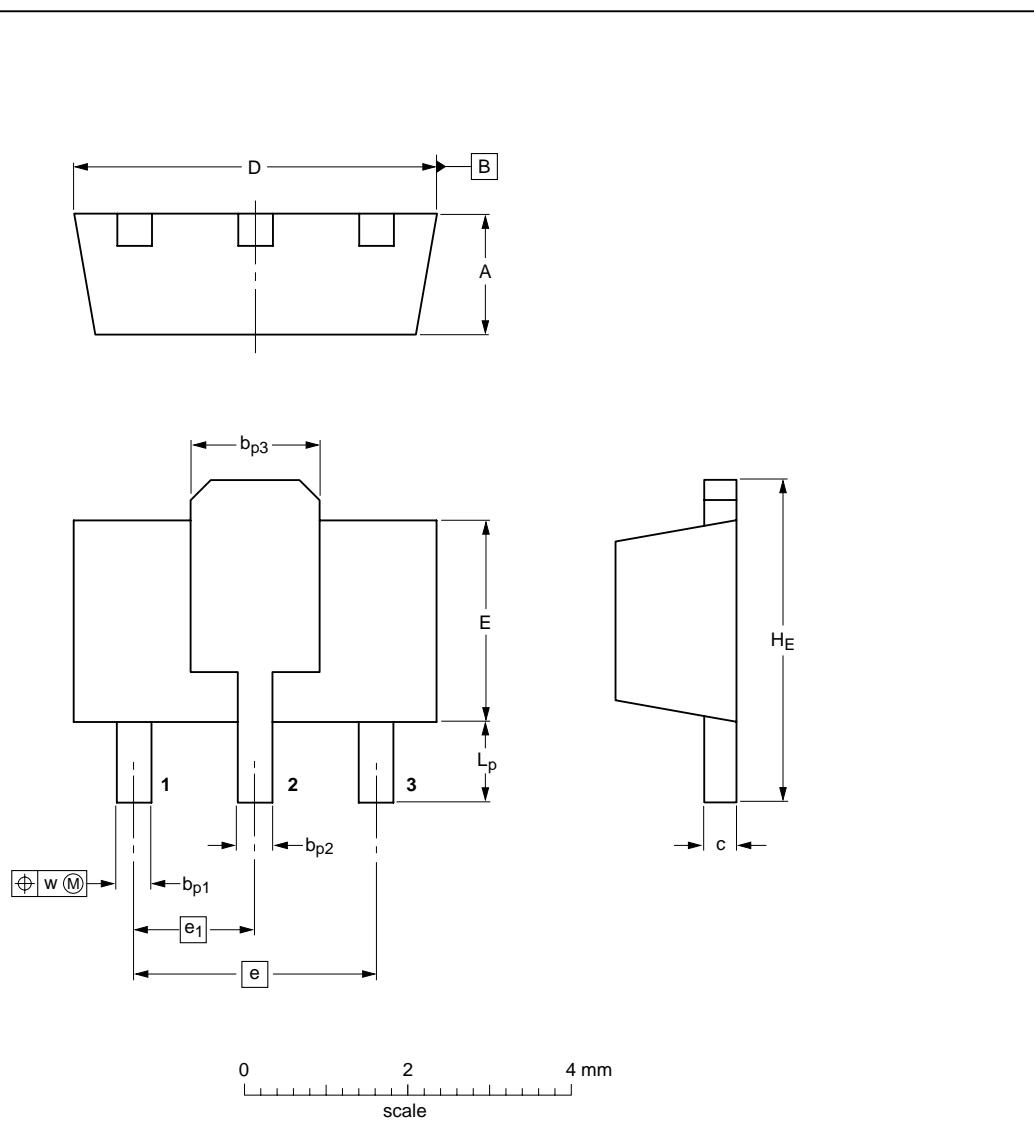
NPN switching transistor

PXT4401

PACKAGE OUTLINE

Plastic surface-mounted package; collector pad for good heat transfer; 3 leads

SOT89



DIMENSIONS (mm are the original dimensions)

| UNIT | A | b_{p1} | b_{p2} | b_{p3} | c | D | E | e | e_1 | H_E | L_p | w |
|------|------------|--------------|--------------|------------|--------------|------------|------------|-----|-------|--------------|------------|------|
| mm | 1.6 1.4 | 0.48 0.35 | 0.53 0.40 | 1.8 1.4 | 0.44 0.23 | 4.6 4.4 | 2.6 2.4 | 3.0 | 1.5 | 4.25 3.75 | 1.2 0.8 | 0.13 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|--------|-------|--|---------------------|--------------------|
| | IEC | JEDEC | JEITA | | | |
| SOT89 | | TO-243 | SC-62 | | | -04-08-03-06-03-16 |

NPN switching transistor

PXT4401

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|--------------------------------|-------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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2. The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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NXP Semiconductors

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This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

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